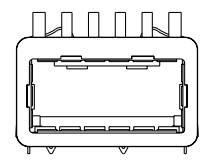
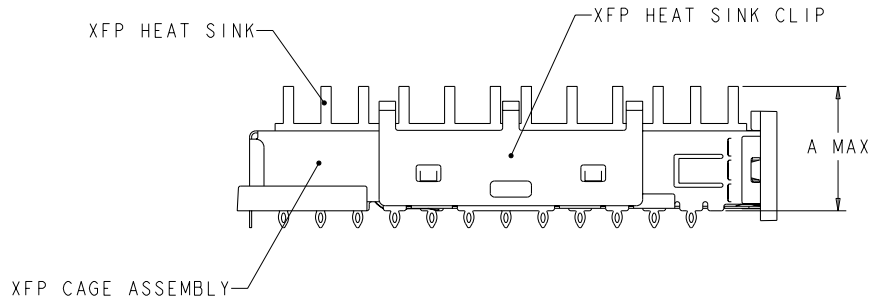
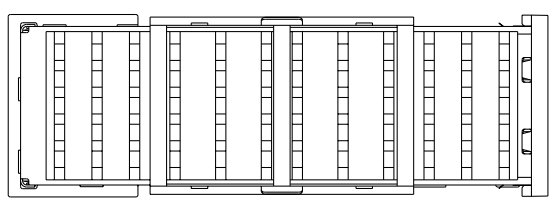


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REVOLUTION		REVISIONS		
P	LYR	DESCRIPTION	DATE	BY
C		REVISED PER ECO-11-005032	11MAR2011	JY CW

1. MATES WITH XFP MSA COMPLIANT TRANSCEIVERS.
2. SEE COMPONENT DRAWINGS FOR COMPONENT DIMENSIONS AND INFORMATION.



13.6	1542656-2	1489948-2	1489951-1	PCI	1888116-2
15.8	1542618-2	1489948-2	1489951-1	SAN	1888116-1
A MAX	HEATSINK PART NUMBER	HEATSINK CLIP PART NUMBER	CAGE PART NUMBER	APPLICATION	PART NUMBER

DIMENSIONS: mm 	TO GERBER'S ONLY OPERATING SPEC'S: 0 PLC ± 1 PLC ± 2 PLC ± 3 PLC ± 4 PLC ± ANGLES ± MATERIAL /FINISH	DWG 28NOV05 CDR J GERACE APP'D J KOPPENHEFFEN NAME M. WALMSLEY PRODUCT SPEC 28NOV05 108-2127 APPLICATION SPEC 114-13096 WEIGHT CUSTOMER DRAWING	Tyco Electronics Harrisburg, PA 17105-3608 XFP KIT ASSEMBLY STATE CASE CODE DRAWING NO A2 00779 © 1888116 RESTRICTED TO
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